

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	CORRECTIVE ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	Corrective Assignment to correct the ADDRESS OF THE SECOND ASSIGNEE FROM "ICHENON-SI" TO --ICHEON-SI-- previously recorded on Reel 037924 Frame 0705. Assignor(s) hereby confirms the ADDRESS OF THE SECOND ASSIGNEE.

## CONVEYING PARTY DATA

Name	Execution Date
MASAHIKO NAKAYAMA	03/19/2014
MASATOSHI YOSHIKAWA	02/25/2014
TADASHI KAI	02/25/2014
YUTAKA HASHIMOTO	02/25/2014
MASARU TOKO	02/27/2014
HIROAKI YODA	03/19/2014
JAE GEUN OH	05/23/2014
KEUM BUM LEE	05/23/2014
CHOON KUN RYU	05/23/2014
HYUNG SUK LEE	05/23/2014
SOOK JOO KIM	05/23/2014

## RECEIVING PARTY DATA

<b>Name:</b>	KABUSHIKI KAISHA TOSHIBA
<b>Street Address:</b>	1-1, SHIBAURA 1-CHOME
<b>Internal Address:</b>	MINATO-KU
<b>City:</b>	TOKYO
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	105-8001
<b>Name:</b>	SK HYNIX INC.
<b>Street Address:</b>	2091, GYEONGCHUNG-DAERO
<b>Internal Address:</b>	BUDAI-EUB
<b>City:</b>	ICHEON-SI, GYEONGGI-DO
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	467-701

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14202802

**CORRESPONDENCE DATA****Fax Number:**

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.*

**Phone:** 212-319-4900  
**Email:** shimmelstein@hhpatent.com  
**Correspondent Name:** HOLTZ HOLTZ & VOLEK  
**Address Line 1:** 630 9TH AVE  
**Address Line 2:** SUITE 1010  
**Address Line 4:** NEW YORK, NEW YORK 10036

<b>ATTORNEY DOCKET NUMBER:</b>	13691
<b>NAME OF SUBMITTER:</b>	STEVEN HIMMELSTEIN
<b>SIGNATURE:</b>	/Steven Himmelstein/
<b>DATE SIGNED:</b>	03/21/2016

**Total Attachments: 9**

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ASSIGNMENT

ACG065818-USA-B  
(1380592)

In consideration of value received, I, having a residence as stated below above my name, the sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of an invention described in an application for United States patent entitled:

MAGNETORESISTIVE ELEMENT AND METHOD OF MANUFACTURING THE SAME

have sold and assigned and do hereby sell and assign to

- 1. KABUSHIKI KAISHA TOSHIBA, a Japanese corporation, having a business address at 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan
- 2. SK hynix Inc., a Korean corporation, having a business address at 2091, Gyeongchung-daero, Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

*[Handwritten signature]* 3/21/16

its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention as disclosed, shown and described in said United States patent application:

(check one)  executed concurrently herewith  
 executed on  
 Application No. , filed

and in and to all applications for patent and patents for invention including all divisions, reissues, continuations, substitutes and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any of said applications; and I authorize and request any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, continued prosecution, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention.

I hereby grant the following law firm the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the Rules of the U.S. Patent and Trademark Office for recordation of this document.

Holtz, Holtz, Goodman & Chick PC, 220 Fifth Avenue - 16th Floor, New York, N.Y.  
10001-7708

ASSIGNMENT

ACG065818-USA-B  
(13S0592)

[1st Inventor]

Residence Address: Seoul, Korea

Mailing Address: c/o IP Division, 35th floor, 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan

Citizenship: Japan

*Masahiko Nakayama*

*Mar. 19, 2014*

Masahiko Nakayama

Date:

[2nd Inventor]

Residence Address: Seoul, Korea

Mailing Address: c/o IP Division, 35th floor, 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan

Citizenship: Japan

*Masatoshi Yoshikawa*

*02/25/2014*

Masatoshi Yoshikawa

Date:

[3rd Inventor]

Residence Address: Seoul, Korea

Mailing Address: c/o IP Division, 35th floor, 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan

Citizenship: Japan

*Tadashi Kai*

*Feb. 25, 2014*

Tadashi Kai

Date:

[4th Inventor]

Residence Address: Seoul, Korea

Mailing Address: c/o IP Division, 35th floor, 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan

Citizenship: Japan

*Yutaka Hashimoto*

*Feb. 25, 2014*

Yutaka Hashimoto

Date:

[5th Inventor]

Residence Address: Seoul, Korea

Mailing Address: c/o IP Division, 35th floor, 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan

Citizenship: Japan

*Masaru Toko*

*Feb. 27, 2014*

Masaru Toko

Date:

ASSIGNMENT

ACG065818-USA-B  
(13S0592)

[6th Inventor]

Residence Address: Seoul, Korea

Mailing Address: c/o IP Division, 35th floor, 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan

Citizenship: Japan

*[Handwritten signature]*

*March 9, 2004*

Hiroaki Yoda

Date:

[7th Inventor]

Residence Address: Icheon-si, Gyeonggi-do, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

*3/21/12*

Jae Geun Oh

Date:

[8th Inventor]

Residence Address: Icheon-si, Gyeonggi-do, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

*3/21/12*

Keum Bum Lee

Date:

[9th Inventor]

Residence Address: Seoul, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

*3/21/12*

Choon Kun Ryu

Date:

[10th Inventor]

Residence Address: Icheon-si, Gyeonggi-do, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

*3/21/12*

Hyung Suk Lee

Date:

ASSIGNMENT

ACG065818-USA-B  
(18S0592)

[6th Inventor]

Residence Address: Seoul, Korea

Mailing Address: c/o IP Division, 35th floor, 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan

Citizenship: Japan

Hiroaki Yoda

Date:

[7th Inventor]

Residence Address: Icheon-si, Gyeonggi-do, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

*Jae Geun Oh*

Jae Geun Oh

Date: May 23, 2014

[8th Inventor]

Residence Address: Icheon-si, Gyeonggi-do, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

*Keum Bum Lee*

Keum Bum Lee

Date: May 23, 2014

[9th Inventor]

Residence Address: Seoul, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

Choon Kun Ryu

Date:

[10th Inventor]

Residence Address: Icheon-si, Gyeonggi-do, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

*Hyung Suk Lee*

Hyung Suk Lee

Date: May 23, 2014

## ASSIGNMENT

ACG065818-USA-B  
(13S0592)

[6th Inventor]

Residence Address: Seoul, Korea

Mailing Address: c/o IP Division, 35th floor, 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan

Citizenship: Japan

Hiroaki Yoda

Date:

[7th Inventor]

Residence Address: Icheon-si, Gyeonggi-do, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

Jae Geun Oh

Date:

[8th Inventor]

Residence Address: Icheon-si, Gyeonggi-do, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

Keum Bum Lee

Date:

[9th Inventor]

Residence Address: Seoul, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

Choon Kun Ryu

Date: May 23, 2014

[10th Inventor]

Residence Address: Icheon-si, Gyeonggi-do, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

Hyung Suk Lee

Date:

ASSIGNMENT

ACG065818-USA-B  
(18S0592)

[11th Inventor]

Residence Address: Icheon-si, Gyeonggi-do, Korea

Mailing Address: c/o Patent Development Team, 4th floor, M7B Bldg., 2091, Gyeongchung-daero,

Budai-eub, Icheon-si, Gyeonggi-do, 467-701 Korea

Citizenship: Republic of Korea

*SK*  
*3/21/16*

*Sook Joo Kim*

Sook Joo Kim

Date: May 23, 2014

*SK*



